

FMW79N60S1HF

FUJI POWER MOSFET

Super J-MOS series

N-Channel enhancement mode power MOSFET

Features

Low on-state resistance Low switching loss easy to use (more controllabe switching dV/dt by Rg)

■ Applications

UPS

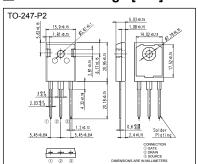
Server

Telecom

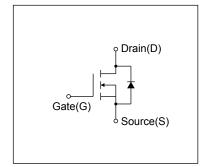
Power conditioner system

Power supply

■ Outline Drawings [mm]



■ Equivalent circuit schematic



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain Sauras Valtara	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Busin Current	l _D	±68	Α	Tc=25°C Note*1
Continuous Drain Current		±43	Α	Tc=100°C Note*1
Pulsed Drain Current	I _{DP}	±204	Α	
Gate-Source Voltage	V _{GS}	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	I _{AR}	13.5	Α	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	3194.4	mJ	Note *3
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/µs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	15	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt	50	A/µs	Note *5
Maximum Bayer Dissination	P _D	2.5	W	T _a =25°C
Maximum Power Dissipation		545	VV	Tc=25°C
One wetting and Change Towns and was a	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature.

Note *2 : T_{ch}≤150°C, See Fig.1 and Fig.2
Note *3 : Starting T_{ch}=25°C, I_{AS}=8.1A, L=89.3mH, V_{DD}=60V, R_G=50Ω, See Fig.1 and Fig.2
E_{AS} limited by maximum channel temperature and avalanche current.

Note *4 : IFS-20A, -di/dt=50A/µs, VopS300V, TchS150°C. Note *5 : IFS-20A, dV/dt=15kV/µs, VopS300V, TchS150°C.

■ Electrical Characteristics at T_c=25°C (unless otherwise specified)

Static Ratings

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I _D =250µA V _{DS} =V _{GS}		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	loss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μΑ
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	Icss	V _{GS} = ±30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =34A V _{GS} =10V		-	0.034	0.04	Ω
Gate resistance	R _G	f=1MHz, open drain		-	1.3	-	Ω

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Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =34A V _{DS} =25V	27.5	55	-	S
Input Capacitance	Ciss	V _{DS} =10V	-	7000	-	
Output Capacitance	Coss	V _{GS} =0V	-	14500	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	1300	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _s =0V V _b =0480V	-	350	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{GS} =0V V _{DS} =0480V ID=constant	-	1330	-	
Turn On Time	t _{d(on)}		-	40	-	
Turn-On Time	t r	∇bb=400V, Ves=10V Ib=34A, Re=6.2Ω See Fig.3 and Fig.4	-	107	-	ns
Turn-Off Time	t _{d(off)}		-	199	-	
Turn-On Time	t f		-	20	-	
Total Gate Charge	Q _G		-	203	-	
Gate-Source Charge	Q _{GS}	V _{DD} =480V, I _D =68A V _{SS} =10V See Fig.5	-	44	-	~_
Gate-Drain Charge	Q _{GD}		-	76	-	nC
Drain-Source crossover Charge	Qsw		-	27	-	

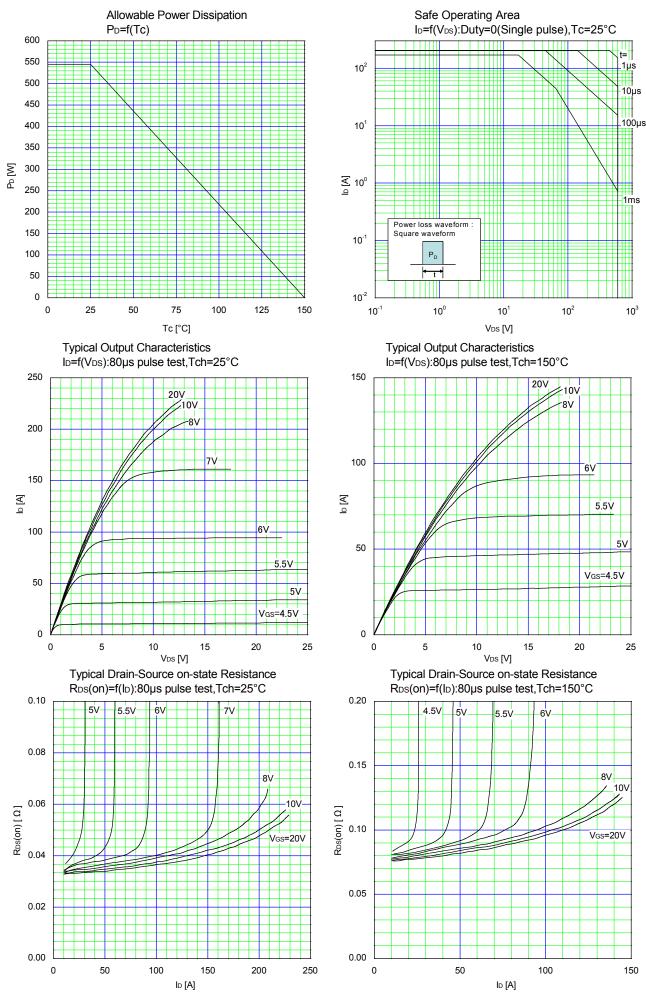
Note *6 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% BV_{DSS}. Note *7 : $C_{o(er)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 80% BV_{DSS}.

Reverse Diode

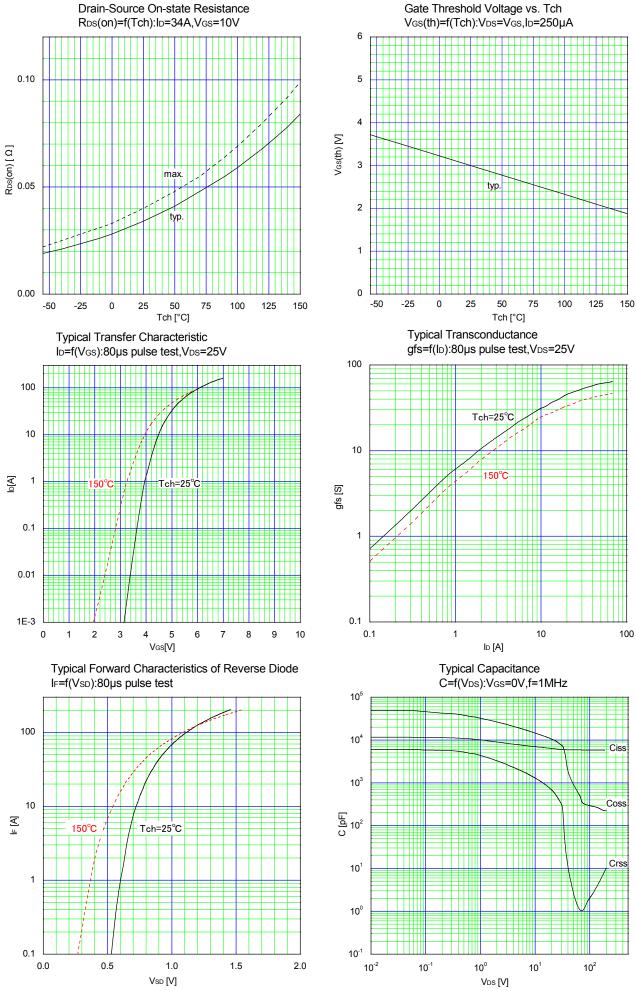
Description	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=19.3mH, T _{ch} =25°C See Fig.1 and Fig.2	13.5	-	-	Α
Diode Forward On-Voltage	V _{SD}	I _F =68A, V _{GS} =0V T _{ch} =25°C	-	1.0	1.35	V
Reverse Recovery Time	trr	I _F =20A, V _{GS} =0V V _{DD} =300V -di/dt=50A/µs T _{ch} =25°C See Fig.6	1	600	-	ns
Reverse Recovery Charge	Qrr		-	8.7	-	μC
Peak Reverse Recovery Current	I _{rp}		-	29	-	Α

■ Thermal Characteristics

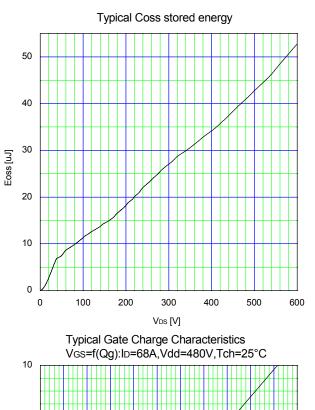
Description	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.23	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	50	°C/W

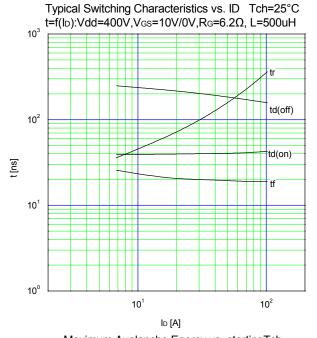


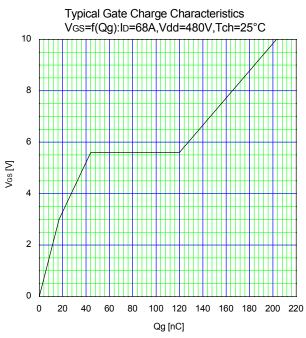
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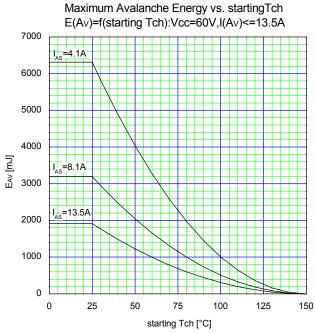


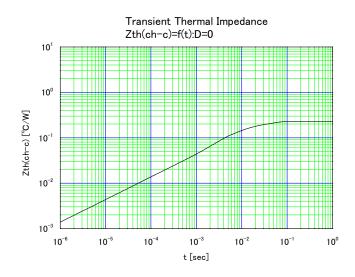
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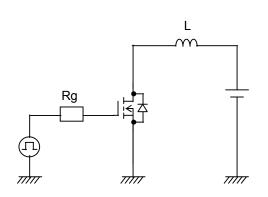












+10V VGS
-15V BVDSS
VDS
UD

Fig.1 Avalanche Test circuit

Fig.2 Operating waveforms of Avalanche Test

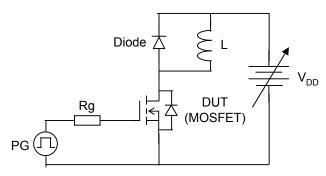


Fig.3 Switching Test circuit

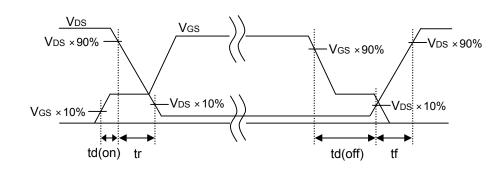


Fig.4 Operating waveform of Switching Test

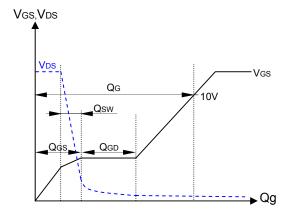


Fig.5 Operating waveform of Gate charge Test

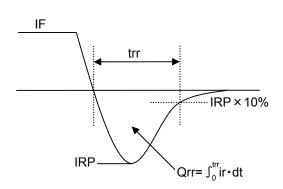
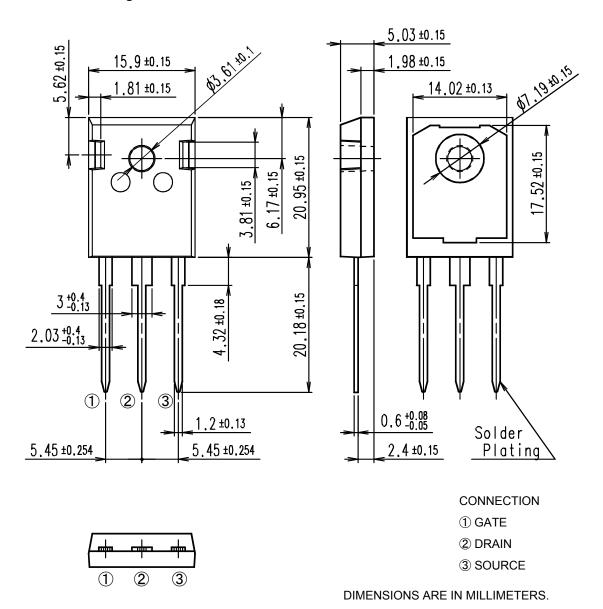
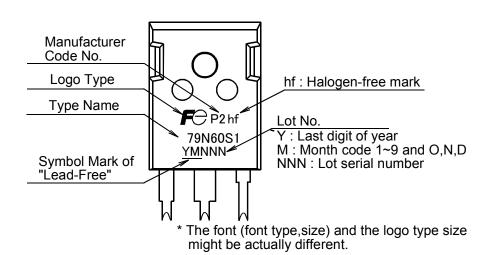


Fig.6 Operating waveform of Body diode Recovery Test

■ Outview: TO-247-P2 Package



Marking



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